L Number	Hits	Search Text	DB	Time stamp
3	52	kim-young-soo.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/27 20:33
_	106	ti same atomic adj layer adj deposition and capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/27 20:32
-	20	ti same atomic adj layer adj deposition and capacitor and bottom adj electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/26 23:23
_	11	ti same atomic adj layer adj deposition and capacitor and nh\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/26 23:24
_	55	and "nh.sub.3" and electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/26 23:26
_	39	and "nh.sub.3" and electrode and capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/26 23:28
_	58	ald with tin and "nh.sub.3" and electrode and capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/26 23:28
_	5	ald near tin and "nh.sub.3" and electrode and capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/26
-	4	ald near tin and "nh.sub.3" and electrode and capacitor and nitrid\$9 same dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/27 00:34
-	3	ald near tin and "nh.sub.3" and electrode and capacitor and nitrid\$9 with dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/27 00:34
-	0	ald near tin and "nh.sub.3" and electrode and capacitor and nitridiz\$6 with dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/27 00:34
_	0	ald near tin and "nh.sub.3" and nitridiz\$6 with dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/27 00:34
_	6	ald and "nh.sub.3" and nitridiz\$6 with dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 00:35

-	6	ald and "nh.sub.3" and nitridiz\$6 with dielectric and tin	USPAT; US-PGPUB;	2004/09/27 00:43
			EPO; JPO; DERWENT; IBM TDB	
_	0	ald and amonia and nitridiz\$6 with	USPAT;	2004/09/27
		dielectric and tin	US-PGPUB;	00:42
		dicicociio ana cin	EPO; JPO;	00.12
	,		DERWENT;	
			IBM TDB	
_	6	ald and ammonia and nitridiz\$6 with	USPAT;	2004/09/27
	ļ	dielectric and tin	US-PGPUB;	00:43
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	130		USPAT;	2004/09/27
		dielectric and tin	US-PGPUB;	00:43
			EPO; JPO;	
			DERWENT;	
	F 1	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	IBM_TDB	2004/00/07
-	51	ald with tin and "nh.sub.3" and nitrid\$8	USPAT;	2004/09/27
		with dielectic	US-PGPUB; EPO; JPO;	00:43
			DERWENT;	
			IBM TDB	
_	8	ald near tin and "nh.sub.3" and nitrid\$8	USPAT;	2004/09/27
		with dielectric	US-PGPUB;	01:05
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	13		USPAT;	2004/09/27
		same dielectric	US-PGPUB;	00:57
İ			EPO; JPO;	
			DERWENT;	
_	0	("6,489,2146,518,6346,551,3996,551,8736,55	IBM_TDB	17700 4 top / 27
-		( 6,469,2146,516,6346,531,3996,531,6736,53	US-PGPUB;	00:58
			EPO; JPO;	00.30
	•		DERWENT;	
			IBM TDB	
-	12		USPAT;	2004/09/27
		("6,551,399") or ("6,551,873") or	US-PGPUB;	00:58
		("6,551,893") or ("6,573,547")).PN.	EPO; JPO;	
			DERWENT;	
		ald many bin and Walt 1 am 1	IBM_TDB	0004/00/07
] -	l o	ald near tin and "nh.sub.3" and	USPAT;	2004/09/27
		nitridation with dielectric	US-PGPUB; EPO; JPO;	01:06
			DERWENT;	
			IBM TDB	
-	0	ald near tin and "nh.sub.3" and	USPAT;	2004/09/27
		nitridations same dielectric	US-PGPUB;	01:06
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	52	· · · · · · · · · · · · · · · · · · ·	USPAT;	2004/09/27
		dielectric	US-PGPUB;	01:06
			EPO; JPO;	
			DERWENT;	
<u>  _                                   </u>	22	ald and "nh.sub.3" and nitridations same	<pre>IBM_TDB USPAT;</pre>	2004/09/27
	22	dielectric and tin	US-PGPUB;	01:06
		and the transfer of the transf	EPO; JPO;	01.00
			DERWENT;	
			IBM TDB	
-	22	ald and "nh.sub.3" and nitridation same	USPAT;	2004/09/27
	[	dielectric and tin	US-PGPUB;	01:06
			EPO; JPO;	
[			DERWENT;	
1			IBM_TDB	

		•		
-	10	ald with tin and "nh.sub.3" and	USPAT;	2004/09/27
		nitridation same dielectric and tin	US-PGPUB;	01:13
			EPO; JPO;	`
			DERWENT;	
			IBM TDB	
_	11	ald and "nh.sub.3" and nitridation with	USPAT;	2004/09/27
		dielectric and tin	US-PGPUB;	01:20
			EPO; JPO;	02.20
			DERWENT;	
]			IBM TDB	
1_	11	ald and "nh.sub.3" and (nitridation or	USPAT;	2004/09/27
		nitrify) with dielectric and tin	US-PGPUB;	01:18
1		meetily, with dictedelle and tin	EPO; JPO;	, 01.10
			DERWENT;	
			IBM TDB	٠.
_	779	438/785	USPAT;	2004/09/27
-	'''	430/703	1	
			US-PGPUB;	01:20
			EPO; JPO;	
			DERWENT;	
1	1074	(429/779) CCTC	IBM_TDB	2004/00/07
-	1074	(438/778).CCLS.	USPAT;	2004/09/27
			US-PGPUB;	01:21
1			EPO; JPO;	
			DERWENT;	
1		(430/775)	IBM_TDB	0004/55/55
-	272	(438/775).CCLS.	USPAT;	2004/09/27
			US-PGPUB;	01:22
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	13	ald adj tin	USPAT;	2004/09/27
			US-PGPUB;	01:22
			EPO; JPO;	_
			DERWENT;	
			IBM_TDB	
-	3	ald adj tin and nitridation	USPAT;	2004/09/27
1			US-PGPUB;	01:23
			EPO; JPO;	
		·	DERWENT;	·
			IBM_TDB	
-	4	ald near tin and nitridation	USPAT;	2004/09/27
]			US-PGPUB;	01:23
			EPO; JPO;	
1			DERWENT;	
			IBM_TDB	
-	32	ald with tin and nitridation	USPAT;	2004/09/27
			US-PGPUB;	01:26
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	2	ald with tin and nitridation with	USPAT;	2004/09/27
		dielectric	US-PGPUB;	01:24
	1		EPO; JPO;	1
	1		DERWENT;	
			IBM TDB	, ,
-	20	"6225168"	USPAT;	2004/09/27
			US-PGPUB;	01:24
			EPO; JPO;	
			DERWENT;	
		·	IBM TDB	
_	3	ald with tin and nitriding with	USPAT;	2004/09/27
	1	dielectric	US-PGPUB;	20:30
			EPO; JPO;	
	1		DERWENT;	
	1		IBM TDB	1
1	4156	(438/396).CCLS.	USPAT;	2004/09/27
_		,	US-PGPUB;	20:31
	1		EPO; JPO;	
			DERWENT;	
			IBM TDB	
L	1	I		1 ·

2	221	(438/399).CCLS.	USPAT;	2004/09/27
			US-PGPUB;	20:31
			EPO; JPO;	
	[		DERWENT;	
			IBM TDB	